FACED PANEL

CEPPO

LS66

SUPPORT: Chipboard, MDF
FORMAT: 5600 x 2070 mm
THICKNESS: from 8 to 38 mm
TEXTURE ORIENTATION: Vertical
BACK TEXTURE: Ceppo
NOMINAL OVERTHICKNESS: +0.1 mm

LAMINATE

CEPPO

LS66

TYPE: HPL
FORMAT: 2760 x 2040 mm
THICKNESS: 0.9 mm

EDGE

CEPPO

LS66

TYPE: ABS
HEIGHT: from 15 to 330 mm
THICKNESS: from 0.5 to 2.0 mm